

FEATURES

- Member of the Texas Instruments Widebus™ Family
- UBT™ Transceiver Combines D-Type Latches and D-Type Flip-Flops for Operation in Transparent, Latched, Clocked, or Clock-Enable Mode
- Operates From 1.65 V to 3.6 V
- Max t_{pd} of 3.2 ns at 3.3 V
- ± 24 -mA Output Drive at 3.3 V
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Performance Tested Per JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)

DESCRIPTION/ORDERING INFORMATION

This 18-bit universal bus transceiver is designed for 1.65-V to 3.6-V V_{CC} operation.

Data flow in each direction is controlled by output-enable (\overline{OEAB} and \overline{OEBA}) and clock-enable ($\overline{CLKENBA}$) inputs. For the A-to-B data flow, the data flows through a single buffer. The B-to-A data can flow through a four-stage pipeline register path, or through a single register path, depending on the state of the select (SEL) input.

Data is stored in the internal registers on the low-to-high transition of the clock (CLK) input, provided that the appropriate $\overline{CLKENBA}$ input is low. The B-to-A data transfer is synchronized with CLK.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

ORDERING INFORMATION

| T_A | PACKAGE ⁽¹⁾ | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|-------------|------------------------|---------------|-----------------------|------------------|
| -40 to 85°C | SSOP - DL | Tube | SN74ALVCH16524DL | ALVCH16524 |
| | | Tape and reel | SN74ALVCH16524DLR | |
| | TSSOP - DGG | Tape and reel | SN74ALVCH16524DGG | ALVCH16524 |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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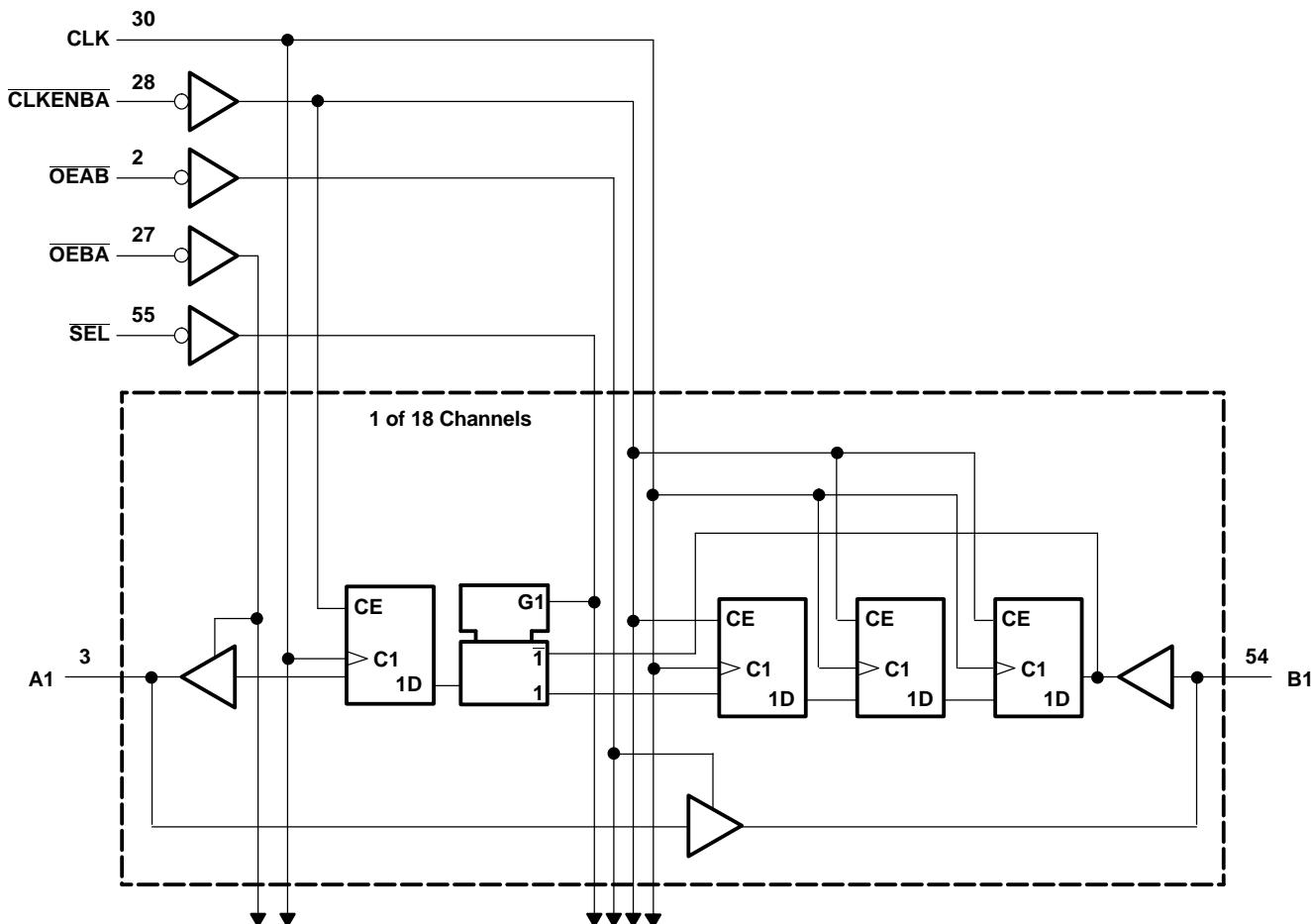
FUNCTION TABLE
 B-TO-A STORAGE ($\overline{OEBA} = L$)

| INPUTS | | | | OUTPUT A |
|----------------------|-----|-----|---|-------------|
| $\overline{CLKENBA}$ | CLK | SEL | B | |
| H | X | X | X | $A_0^{(1)}$ |
| L | ↑ | H | L | L |
| L | ↑ | H | H | H |
| L | ↑ | L | L | $L^{(2)}$ |
| L | ↑ | L | H | $H^{(2)}$ |

(1) Output level before the indicated steady-state input conditions were established

(2) Four positive CLK edges are needed to propagate data from B to A when SEL is low.

LOGIC DIAGRAM (POSITIVE LOGIC)



ABSOLUTE MAXIMUM RATINGS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | | MIN | MAX | UNIT |
|---------------|-------------------------------------------------|---------------------------------|----------------|----------------|
| V_{CC} | Supply voltage range | -0.5 | 4.6 | V |
| V_I | Input voltage range | Except I/O ports ⁽²⁾ | -0.5 | 4.6 |
| | | I/O ports ⁽²⁾⁽³⁾ | -0.5 | $V_{CC} + 0.5$ |
| V_O | Output voltage range ⁽²⁾⁽³⁾ | -0.5 | $V_{CC} + 0.5$ | V |
| I_{IK} | Input clamp current | $V_I < 0$ | -50 | mA |
| I_{OK} | Output clamp current | $V_O < 0$ | -50 | mA |
| I_O | Continuous output current | | ± 50 | mA |
| | Continuous current through each V_{CC} or GND | | ± 100 | mA |
| θ_{JA} | Package thermal impedance ⁽⁴⁾ | DGG package | 64 | °C/W |
| | | DL package | 56 | |
| T_{stg} | Storage temperature range | -65 | 150 | °C |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) This value is limited to 4.6 V maximum.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.

RECOMMENDED OPERATING CONDITIONS⁽¹⁾

| | | MIN | MAX | UNIT |
|---------------------|------------------------------------|----------------------------------------------|----------------------|------|
| V_{CC} | Supply voltage | 1.65 | 3.6 | V |
| V_{IH} | High-level input voltage | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | $0.65 \times V_{CC}$ | V |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 1.7 | |
| | | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | 2 | |
| V_{IL} | Low-level input voltage | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | $0.35 \times V_{CC}$ | V |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 0.7 | |
| | | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | 0.8 | |
| V_I | Input voltage | 0 | V_{CC} | V |
| V_O | Output voltage | 0 | V_{CC} | V |
| I_{OH} | High-level output current | $V_{CC} = 1.65 \text{ V}$ | -4 | mA |
| | | $V_{CC} = 2.3 \text{ V}$ | -12 | |
| | | $V_{CC} = 2.7 \text{ V}$ | -12 | |
| | | $V_{CC} = 3 \text{ V}$ | -24 | |
| I_{OL} | Low-level output current | $V_{CC} = 1.65 \text{ V}$ | 4 | mA |
| | | $V_{CC} = 2.3 \text{ V}$ | 12 | |
| | | $V_{CC} = 2.7 \text{ V}$ | 12 | |
| | | $V_{CC} = 3 \text{ V}$ | 24 | |
| $\Delta t/\Delta V$ | Input transition rise or fall rate | | 10 | ns/V |
| T_A | Operating free-air temperature | -40 | 85 | °C |

- (1) All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

SN74ALVCH16524
18-BIT REGISTERED BUS TRANSCEIVER
WITH 3-STATE OUTPUTS

SCES080E—JULY 1996—REVISED OCTOBER 2004

 **TEXAS**
INSTRUMENTS
www.ti.com

ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | V _{CC} | MIN | TYP ⁽¹⁾ | MAX | UNIT |
|--------------------------------|------------------------------------------------------------------------------|-----------------------------------------|-----------------|--------------------|-----|---------|
| V _{OH} | I _{OH} = -100 μ A | 1.65 V to 3.6 V | V _{CC} | - 0.2 | | V |
| | I _{OH} = -4 mA | 1.65 V | | 1.2 | | |
| | I _{OH} = -6 mA | 2.3 V | | 2 | | |
| | I _{OH} = -12 mA | 2.3 V | | 1.7 | | |
| | | 2.7 V | | 2.2 | | |
| | | 3 V | | 2.4 | | |
| V _{OL} | I _{OL} = -24 mA | 3 V | | 2 | | V |
| | I _{OL} = 100 μ A | 1.65 V to 3.6 V | | 0.2 | | |
| | I _{OL} = 4 mA | 1.65 V | | 0.45 | | |
| | I _{OL} = 6 mA | 2.3 V | | 0.4 | | |
| | I _{OL} = 12 mA | 2.3 V | | 0.7 | | |
| | | 2.7 V | | 0.4 | | |
| I _I | V _I = V _{CC} or GND | 3.6 V | | ±5 | | μ A |
| I _{I(hold)} | V _I = 0.58 V | 1.65 V | | 25 | | μ A |
| | V _I = 1.07 V | 1.65 V | | -25 | | |
| | V _I = 0.7 V | 2.3 V | | 45 | | |
| | V _I = 1.7 V | 2.3 V | | -45 | | |
| | V _I = 0.8 V | 3 V | | 75 | | |
| | V _I = 2 V | 3 V | | -75 | | |
| | V _I = 0 to 3.6 V ⁽²⁾ | 3.6 V | | ±500 | | |
| I _{OZ} ⁽³⁾ | V _O = V _{CC} or GND | 3.6 V | | ±10 | | μ A |
| I _{CC} | V _I = V _{CC} or GND, I _O = 0 | 3.6 V | | 40 | | μ A |
| ΔI_{CC} | One input at V _{CC} - 0.6 V, Other inputs at V _{CC} or GND | 3 V to 3.6 V | | 750 | | μ A |
| C _i | Control inputs | V _I = V _{CC} or GND | 3.3 V | | 3 | pF |
| C _{io} | A or B ports | V _O = V _{CC} or GND | 3.3 V | | 7 | pF |

(1) All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

(2) This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

(3) For I/O ports, the parameter I_{OZ} includes the input leakage current.

TIMING REQUIREMENTS

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

| | | V _{CC} = 1.8 V | V _{CC} = 2.5 V ± 0.2 V | | V _{CC} = 2.7 V | | V _{CC} = 3.3 V ± 0.3 V | | UNIT |
|--------------------|---------------------------------|-------------------------|------------------------------------|-----|-------------------------|-----|------------------------------------|-----|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | |
| f _{clock} | Clock frequency | (1) | | 120 | | 125 | | 150 | MHz |
| t _w | Pulse duration, CLK high or low | (1) | | 3.2 | | 3.2 | | 3 | ns |
| t _{su} | Setup time | B data before CLK↑ | (1) | 1.5 | | 1.2 | | 1.1 | ns |
| | | SEL before CLK↑ | (1) | 2.7 | | 2.4 | | 2.1 | |
| | | CLKENBA before CLK↑ | (1) | 2.7 | | 2.6 | | 2 | |
| t _h | Hold time | B data after CLK↑ | (1) | 1 | | 0.6 | | 1.2 | ns |
| | | SEL after CLK↑ | (1) | 0.5 | | 0.2 | | 0.8 | |
| | | CLKENBA after CLK↑ | (1) | 0.1 | | 0.1 | | 0.3 | |

(1) This information was not available at the time of publication.

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CC} = 1.8\text{ V}$ | $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ | | $V_{CC} = 2.7\text{ V}$ | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ | | UNIT | |
|-----------|----------------------------------------|----------------|-------------------------|------------------------------------------|-----|-------------------------|------------------------------------------|-----|------|-----|
| | | | MIN | TYP | MIN | MAX | MIN | MAX | | |
| f_{max} | | | (1) | | 120 | | 125 | | 150 | MHz |
| t_{pd} | A | B | (1) | | 1 | 3.9 | 3.8 | 1 | 3.2 | ns |
| | CLK | A | (1) | | 1 | 6.1 | 6.2 | 1 | 5.2 | |
| t_{en} | \overline{OEAB} or \overline{OEBA} | A or B | (1) | | 1 | 6.1 | 6.1 | 1 | 5.1 | ns |
| t_{dis} | \overline{OEAB} or \overline{OEBA} | A or B | (1) | | 1 | 6.3 | 5.4 | 1 | 4.9 | ns |

(1) This information was not available at the time of publication.

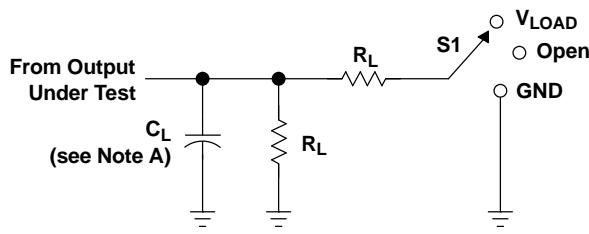
OPERATING CHARACTERISTICS

$T_A = 25^\circ\text{C}$

| PARAMETER | TEST CONDITIONS | $V_{CC} = 1.8\text{ V}$ | $V_{CC} = 2.5\text{ V}$ | $V_{CC} = 3.3\text{ V}$ | UNIT |
|----------------------------------------------|------------------|-------------------------|-------------------------|-------------------------|------|
| | | TYP | TYP | TYP | |
| C_{pd} Power dissipation capacitance | Outputs enabled | (1) | 160 | 160 | pF |
| | Outputs disabled | (1) | 160 | 160 | |

(1) This information was not available at the time of publication.

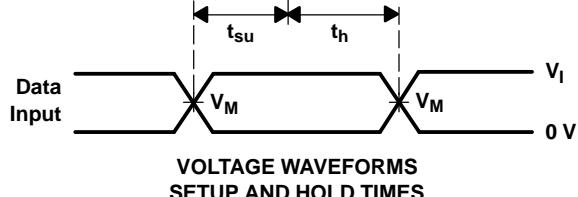
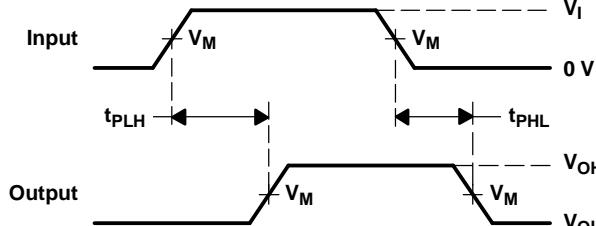
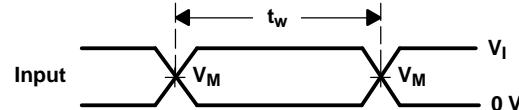
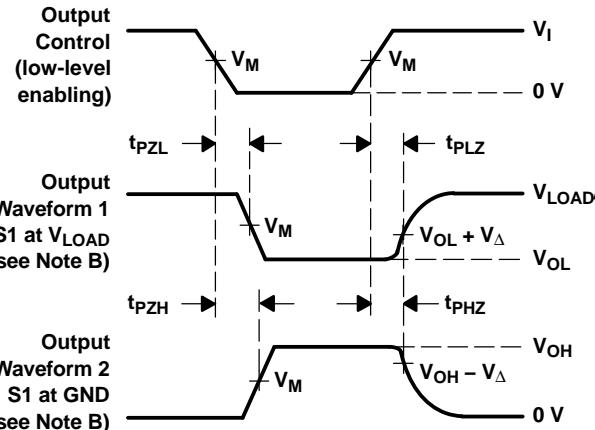
PARAMETER MEASUREMENT INFORMATION



| TEST | $S1$ |
|-------------------|------------|
| t_{pd} | Open |
| t_{PLZ}/t_{PZL} | V_{LOAD} |
| t_{PHZ}/t_{PZH} | GND |

LOAD CIRCUIT

| V_{CC} | INPUT | | V_M | V_{LOAD} | C_L | R_L | V_Δ |
|------------------------------------|----------|-----------------------|------------|-------------------|-------|--------------|------------|
| | V_I | t_r/t_f | | | | | |
| $1.8 \text{ V} \pm 0.15 \text{ V}$ | V_{CC} | $\leq 2 \text{ ns}$ | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 1 k Ω | 0.15 V |
| $2.5 \text{ V} \pm 0.2 \text{ V}$ | V_{CC} | $\leq 2 \text{ ns}$ | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 500 Ω | 0.15 V |
| 2.7 V | 2.7 V | $\leq 2.5 \text{ ns}$ | 1.5 V | 6 V | 50 pF | 500 Ω | 0.3 V |
| $3.3 \text{ V} \pm 0.3 \text{ V}$ | 2.7 V | $\leq 2.5 \text{ ns}$ | 1.5 V | 6 V | 50 pF | 500 Ω | 0.3 V |

VOLTAGE WAVEFORMS
SETUP AND HOLD TIMESVOLTAGE WAVEFORMS
PROPAGATION DELAY TIMESVOLTAGE WAVEFORMS
PULSE DURATIONVOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

NOTES:

- C_L includes probe and jig capacitance.
- Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- All input pulses are supplied by generators having the following characteristics: PRR $\leq 10 \text{ MHz}$, $Z_O = 50 \Omega$.
- The outputs are measured one at a time, with one transition per measurement.
- t_{PLZ} and t_{PHZ} are the same as t_{pd} .
- t_{PZL} and t_{PZH} are the same as t_{en} .
- t_{PLH} and t_{PHL} are the same as t_{pd} .
- All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|-----------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| SN74ALVCH16524DL | Active | Production | SSOP (DL) 56 | 20 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | ALVCH16524 |
| SN74ALVCH16524DL.B | Active | Production | SSOP (DL) 56 | 20 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | ALVCH16524 |

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

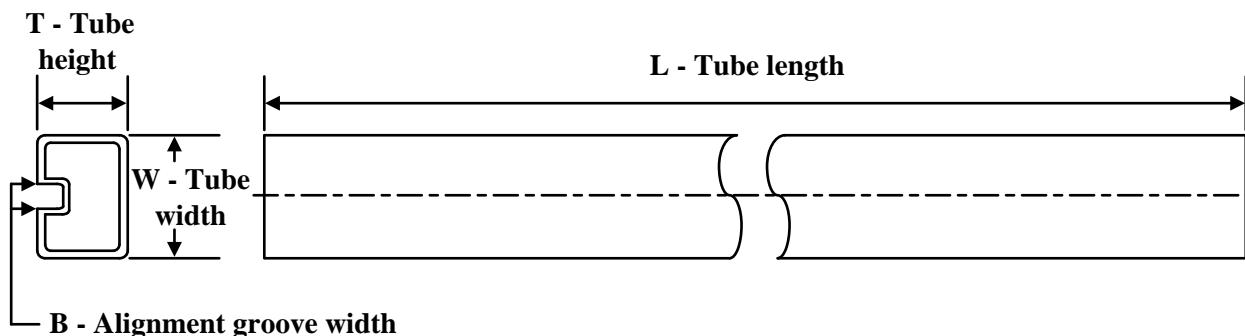
⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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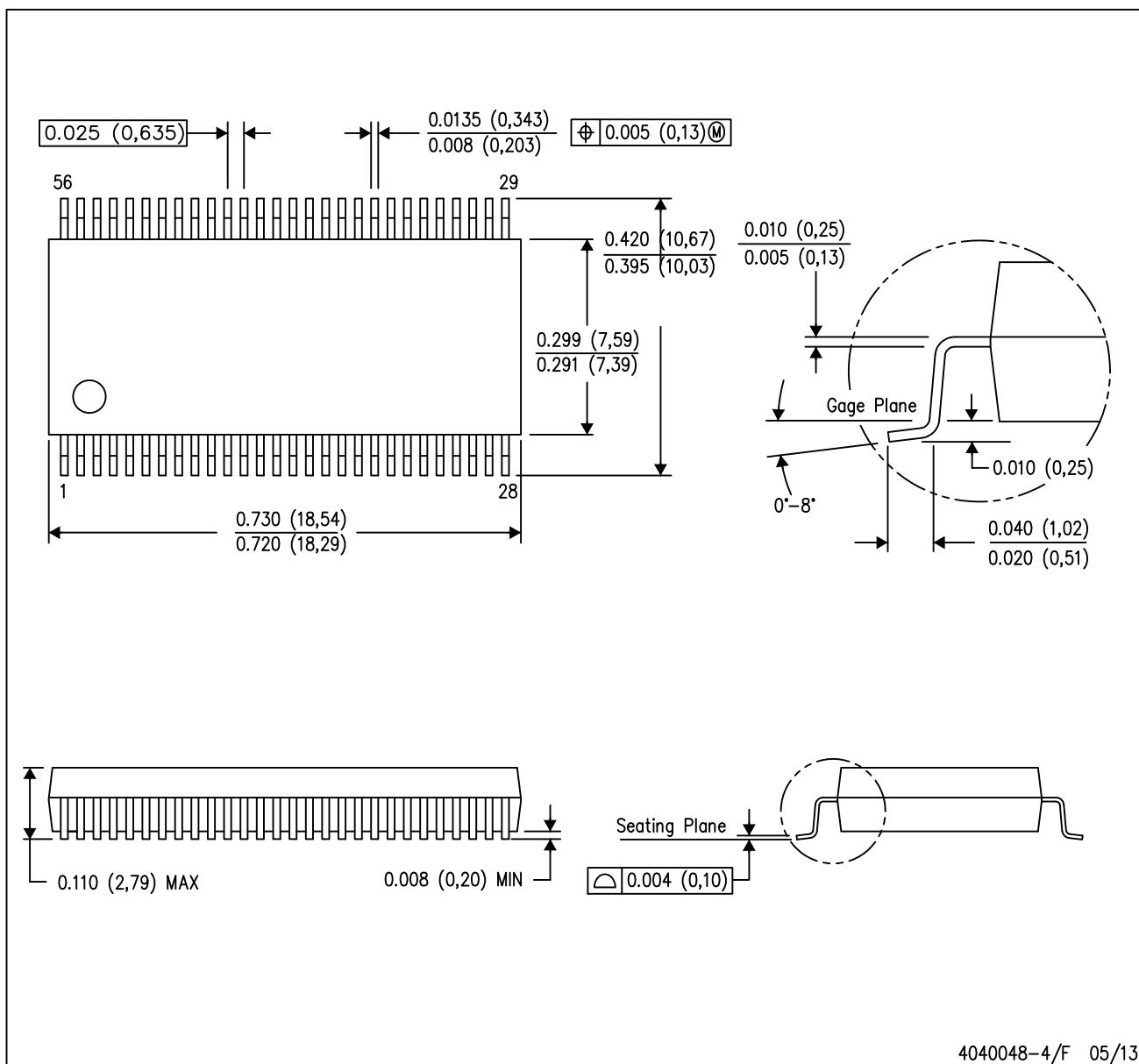
TUBE


*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μ m) | B (mm) |
|--------------------|--------------|--------------|------|-----|--------|--------|--------------|--------|
| SN74ALVCH16524DL | DL | SSOP | 56 | 20 | 473.7 | 14.24 | 5110 | 7.87 |
| SN74ALVCH16524DL.B | DL | SSOP | 56 | 20 | 473.7 | 14.24 | 5110 | 7.87 |

DL (R-PDSO-G56)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0.15).
- Falls within JEDEC MO-118

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